2015, Spring Semester

Energy Engineering (Class 458.624)

Professor

□ DaeHyeongKim :302-816,880-1634,dkim98@snu.ackr □ Classroom :302-720

 \Box C hass t in e : M onday, W ednesday 1100 ~ 12:15

Textbook

- (1) Introduction to Solid State Physics (Charles Kittel)
- (2) Solid State Electronic Devices (Ben G Streetman, Sanjay Kum ar Benerjee)

CrystalS tructure and Bonding

In this chapter, our interest is in

(1) CrystalS tructures and Properties
(2) G rain Boundaries
(3) Lattice Classification
(4) Close Packing and Packing Efficiency
(5) Typical CrystalS tructures
(6) Planes and Directions
(7) Epitaxial G rowth
(8) Types of Bonding in Crystals

CrystalStructures

- Crystalstructure tells how atom s are arranged in the solid.
- Many properties of materials are affected by their crystalstructure.
- Typicalmethod to check the crystalstructure :X-ray scattering



 However, not all solids are crystal: som e have no periodic structure at all (am orphous), and others have m any sm all regions of single crystalm aterials (polycrystal).



G rain boundaries

G rain boundaries

 \sim interfaces where crystals of different orientations m eet

~ crystals on each side of the boundary being identical except in orientation ~ grain boundary areas contain defects, dis boations, and impurities

-Since grain boundaries are defects in the crystal structure they tend to decrease the electrical and therm alconductivity of the material.

-The high interfacial lenergy and relatively weak bonding in most grain boundaries often makes them preferred sites for the onset of corrosion.

-Grain boundaries are in general only a few nanom eters wide. In common materials, crystallites are large enough that grain boundaries account for a small fraction of the material.

- In nanocrystalline solids, however, grain boundaries become a significant volume fraction of the material, with profound effects on material properties. In the limit of small crystallites, the material ceases to have any crystalline character, and thus becomes an amorphous solid.

Diam ond vs G raphite

Why is the crystalstructure important? Let's see examples..



- Both diam ond and graphite consist of only 1kind of atom, carbon.
- The difference is in how those atom s are arranged: diam ond has FCC structure and graphite has planar, by ered structure of hexagonal honeycom b by er (graphene).
- Diam ond is transparent and very hard. And diam ond is chem ically inert.
- Graphite is black and soft, and easy to be exfoliated into graphene layers. Graphite is very useful for catalyzing reactions (electrochem icalelectrodes).
- The carbon atoms in diam ond are each bound to 4 others in a 3-dimensional network (FCC).
 To change the shape of a diam ond or break it requires many of these strong bonds be broken, which explains its superb strength. Since there is little room for other molecules to get into the structure, diam ond is not very reactive.
- Graphite consists of hexagonal sheets. Each sheet is weakly bound and spaces between the byers a low other molecules to enter, explaining catalytic properties.

Cubic Lattice



- Cubic Lattices: above figures are unit cells for three types of cubic lattice structures.
- SC (simple cubic), BCC (body-centered cubic), FCC (face-centered cubic)
- We can calculate the max fraction of the lattice volume filled with atoms by assuming atoms as hard spheres (Let's see FCC case).
- FCC (right figure): "is the lattice constant. The distance between atoms is $\sqrt{2a/2}$. The radius of atom is $\sqrt{2a/4}$.
- Since there are 4 atoms per cube, the packing fraction is as follows: volume of atom $\times 4 / volume of cube \times 100 = 74\%$



Planes and D irections

- When we discuss about single crystalmaterials, it is very useful to use planes and directions of the lattice, such as [hkl], where h, k, lare integers.
- For example, [100] surface or [111] surface of single crystalsilicon wafer have different electrical and chemical properties. [100] surface has higher electron mobility and higher etching rate than [111] surface.
- The three integers describing a particular plane are found in the following way:
 - (1) Find the intercepts of the plane with the crystal axes. Then express these intercepts by using basis vectors multiplied with integers.
 - (2) Take the reciprocal of these integers. Then reduce these to the sm allest set of integers h,k, and l.
 - (3) Label the plane as [hkl].

Exampe)

- The plane on the right figure has intercepts at 2a,4b, and 1c.
- The rec procas are $\frac{1}{2}$, $\frac{1}{4}$, and 1.
- These are reduced to 2, 1, and 4.
- Therefore the plane has the lof [214].



Planes and Directions



Figure. Crystaldirections in the cubic lattice

- Crystaldirections have the same relationship with the labeling of the plane. In other words, [214] plane has the crystaldirection of [214].
- The body diagonal of cubic lattice (above, left fram e) has [111] direction.
- M any directions of the lattice are equivalent. The crystalaxes in the cubic lattice [100], [0 10], and [001] are all equivalent and are called < 100> directions. (See above figure, on the right frame)



Figure. [100],[010],and [001]crystalphaes

Diam ond Lattice



- Many important sem iconductor crystals (Si,Ge,C) have diam ond lattice structure, which is composed of fcc lattices.
- The diam ond structure can be thought of as an fcc lattice with an extra atom placed at a/4+b/4+c/4 from each of the fcc atom s.
- Above figures show diam ond lattice structure: a unit cellof two fcc structures (left), its top view (center) and 3D view (right).

CrystalP lanes of S i

Unit cell:



View in <100> direction View in <110> direction

A real density: $2.0/a^2$

A rea I dens it y: $282/a^2$

View in <11 \triangleright direction



A rea I dens it y: 2 3 $1/a^2$

Zinc B lend Lattice

- Many important IIHV compound sem iconductor crystals (GaAs,GaN, hP) have zinc blend lattice structure, which is sim ilar with diam ond structure.
- The basic structure (two m is a ligned fcc structures) is same.But if the atom s of two fcc structures are same, then it is diam ond structure, while if two are different, then it is zinc blend structure.
- Compound sem iconductors are important for optoelectronic devices, such as light em itting dibdes or photodetectors, and high speed devices (MESFET).

Buk CrystalG rowth

- Buksingle crystalsilicon is made through Czochralskim ethod.
- Sismelted in qualtz-lined graphite crucble, whose temperature is > 1400° C.
- Single crystal seed is dipped into the molten Siand pulled to make Singot.
- Cutting and polishing finishes the fabrication of silicon wafers.
- Most silicon wafers have [100] surface due to its high mobility.

Bondings between A tom s

Types of Bonding in Crystals

Between atoms (1) M etallic Bonding (2) bnic Bonding (3) Covalent Bonding

Between molecules (1) Hydrogen Bonding (2) Van der Waals Force

Metallic Bonding

Definition

-a bond form ed by the attract on between positively charged m etal on (cation) and the shared electrons that surround it (sea of electrons; electron clouds) ex.Cu

- Properties
 - -Conductivity:Good;electrons can move freely
 - -Mechanicalproperty:maleabe; attice structure is flexible

\leftarrow Sea of electrons

bnic Bonding

 $U(R) = -N \frac{\alpha e^2}{4\pi \varepsilon_0 R} + N \frac{A}{R^n}$ attractive (Coulomb)

Usually involve atoms of strongly different electro-negativity Bond form ed by transfer of electrons

Examples; NaCl, CaCl, K_20

Strong electrical attractions between oppositely charged ions: strong bonds

-high melting/boiling point

-conductivity

sold: bns are so c bse together, fixed positions, (can't m ove)

NO conductivity

liquid: ions are freely moving due to a broken lattice structure G ood conductivity

Cova lent Bonding

Definition

-Chem icalbond in which two atoms share a pair of valence electrons

- -Between non-metallicelements of similar electronegativity
- -Stable non-bnizing particles: they are not conductors at any state
- -Can be a single, double, or triple bond

singb,2e-s (-);doubb,4e-s (=);tripb,6e-s(=)

- -Mostly bw melting/boiling points
- 2 types of bonds
 - 🗆 Non Polar

-bonded atom s that share ers equally

-sameatoms bonded

ex.CI-CI:CL

🗆 Pohr

- -bonded atoms that do not share es equally
- -different atom s bonded

Hydrogen Bonding

A special case of perm anent dipole-dipole interactions

Properties

-They are stronger than Van der Waa's forces (next slide)

-M o becubes with hydrogen bonds have higher BPs than mobecubes that don't What we need...

-A hydrogen atom covalently bonded to an electronegative atom ... N, 0 or F.

-A bne pair of electrons on the electronegative atom .

van der Waals Force

- Weak interaction forces due to the quantum fluctuation of charge, which causes arising of temporary dipole moments and weak attractive force
- A lthough Van der Waab forces are weak, they are often the only attractive force between molecules.